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(71) Applicant (for all designated States except US): **LOCKHEED MARTIN CORPORATION** [US/US]; 6801 Rockledge Drive, Bethesda, MD 20817-1877 (US).

(72) Inventors; and

(75) Inventors/Applicants (for US only): **ZINN, Alfred, A.** [US/US]; 1073 Maddux Drive, Palo Alto, CA 94303 (US). **LU, Paul, P.** [US/US]; 729 Applause Place, San Jose, CA 95134 (US).

(74) Agent: **ITRI, Mark, J.**; Mcdermott Will & Emery LLP, 18191 Von Karman, Suite 500, Irvine, CA 92612 (US).

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(54) Title: NANOPARTICLE COMPOSITION AND METHODS OF MAKING THE SAME

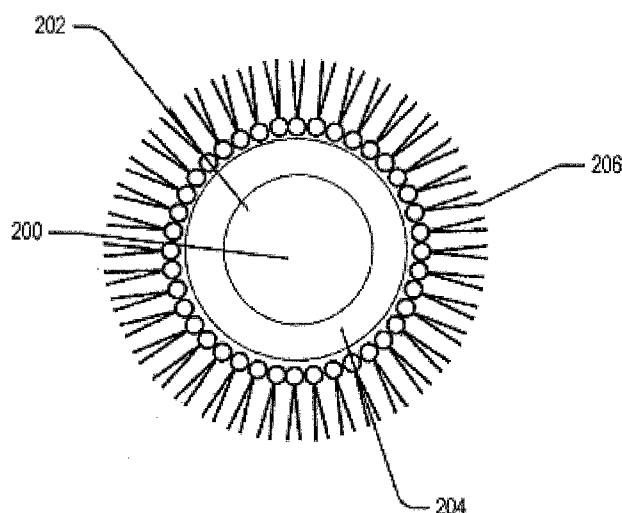


Figure 1

(57) Abstract: A method of fabricating copper nanoparticles includes heating a copper salt solution that includes a copper salt, an *N,N'*-dialkylethylenediamine, and a C6-C18 alkylamine in an organic solvent to a temperature between about 30°C to about 50°C; heating a reducing agent solution that includes a reducing agent, an *N,N'*-dialkylethylenediamine, and a C6-C18 alkylamine in an organic solvent to a temperature between about 30°C to about 50°C; and adding the heated copper salt solution to the heated reducing agent solution, thereby producing copper nanoparticles. A composition includes copper nanoparticles, a C6-C18 alkylamine and an *N,N'*-dialkylethylenediamine ligand. Such copper nanoparticles in this composition have a fusion temperature between about 100°C to about 200°C. A surfactant system for the stabilizing copper nanoparticles includes an *N,N'*-dialkylethylenediamine and a C6-C18 alkylamine.